

- ★ Super Low Gate Charge
- ★ Green Device Available
- ★ Excellent Cdv/dt effect decline
- ★ Advanced high cell density Trench technology

Product Summary



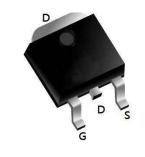
BVDSS	RDSON	ID	
100V	15mΩ	60A	

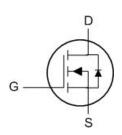
Description

The XR60N10H is the highest performance trench N-ch MOSFETs with extreme high cell density, which provide excellent RDSON and gate charge for most of the synchronous buck converter applications.

The XR60N10H meet the RoHS and Green Product requirement, 100% EAS guaranteed with full function reliability approved.

TO252-3L Pin Configuration





Absolute Maximum Ratings

Symbol	Parameter	Rating	Units
V _{DS}	Drain-Source Voltage	100	V
V _{GS}	Gate-Source Voltage	±20	V
I _D @T _C =25°C	Continuous Drain Current, V _{GS} @ 10V ^{1,6}	60	Α
I _D @T _C =100°C	Continuous Drain Current, V _{GS} @ 10V ^{1,6}	38	А
I _{DM}	Pulsed Drain Current ²	240	Α
EAS	Single Pulse Avalanche Energy ³	350	mJ
las	Avalanche Current	21	А
P _D @T _C =25°C	Total Power Dissipation ⁴	154	W
T _{STG}	Storage Temperature Range	-55 to 150	°C
TJ	Operating Junction Temperature Range	-55 to 150	°C

Thermal Data

Symbol	Parameter	Тур.	Max.	Unit
R _{0JA}	Thermal Resistance Junction-Ambient ¹			°C/W
R _θ JC	Thermal Resistance Junction-Case ¹		0.98	°C/W



Electrical Characteristics (T_J=25 °C, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V , I _D =250uA	100			V
$\triangle BV_{DSS}/\triangle T_{J}$	BV _{DSS} Temperature Coefficient	Reference to 25°C , I _D =1mA				V/°C
Dancer	Static Drain-Source On-Resistance ²	V _{GS} =10V , I _D =36A		15	20	mΩ
R _{DS(ON)}	Static Drain-Source On-Nesistance	V _{GS} =4.5V , I _D 36A				11152
V _{GS(th)}	Gate Threshold Voltage	V _{GS} =V _{DS} . In =250uA	2	3	4	V
$\triangle V_{GS(th)}$	V _{GS(th)} Temperature Coefficient	VGS-VDS, ID-250UA				mV/°C
	Drain Source Leakage Current	V _{DS} =100V , V _{GS} =0V , T _J =25°C			1	
I _{DSS}	Drain-Source Leakage Current	V _{DS} =100V, V _{GS} =0V , T _J =100°C			100	uA
I _{GSS}	Gate-Source Leakage Current	$V_{GS} = \pm 20V$, $V_{DS} = 0V$			±100	nA
gfs	Forward Transconductance V _{DS} =5V , I _D =36A					S
R _g	Gate Resistance	V _{DS} =0V , V _{GS} =0V , f=1MHz				Ω
Qg	Total Gate Charge			87		
Q _{gs}	Gate-Source Charge	V_{DS} =30V , V_{GS} =10V , I_{D} =36A		27		nC
Q_{gd}	Gate-Drain Charge			21		
T _{d(on)}	Turn-On Delay Time			22		
Tr	Rise Time	VGS=10V,		9.6		
T _{d(off)}	Turn-Off Delay Time	VDD=30V, RG=2.5Ω,		60		ns
T _f	Fall Time	ID=2.4A ,		24		
C _{iss}	Input Capacitance			6249		
Coss	Output Capacitance V _{DS} =25V , V _{GS} =0V , f=1MHz			279		pF
C _{rss}	Reverse Transfer Capacitance			196		

Diode Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Is	Continuous Source Current ^{1,4}	V _G =V _D =0V , Force Current			60	Α
VsD	Diode Forward Voltage ²	V _{GS} =0V , I _S =36A , T _J =250			1.2	V
t _{rr}	Reverse Recovery Time	IF=34A , di/dt=100A/μs ,		33		nS
Q _{rr}	Reverse Recovery Charge	T _J =250		54		nC

Notes:1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature

- 3. Pulse Test: Pulse Width≤300µs, Duty Cycle≤0.5%



Typical Performance Characteristics

Figure1: Output Characteristics

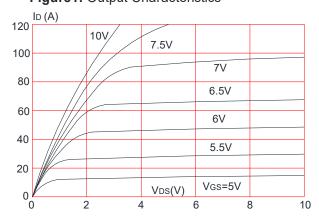


Figure 3:On-resistance vs. Drain Current

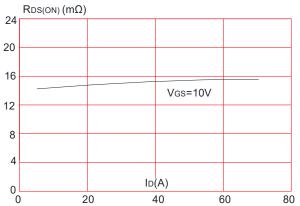


Figure 5: Gate Charge Characteristics

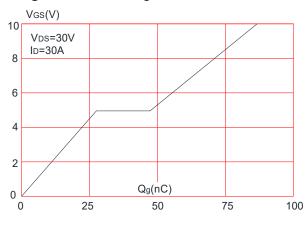


Figure 2: Typical Transfer Characteristics

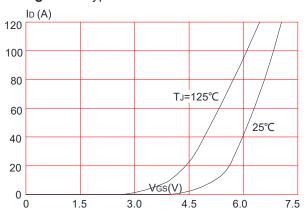


Figure 4: Body Diode Characteristics

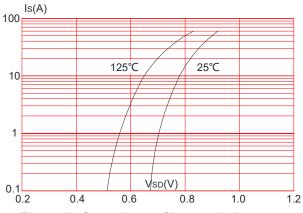


Figure 6: Capacitance Characteristics

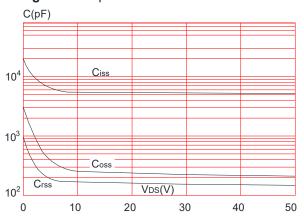




Figure 7: Normalized Breakdown Voltage vs. Junction Temperature

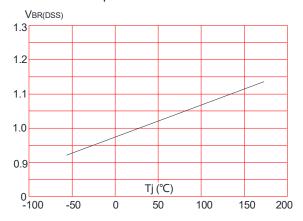


Figure 9: Maximum Safe Operating Area

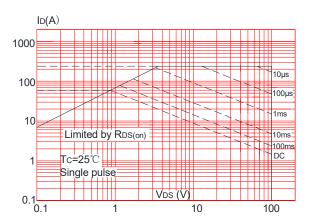


Figure.11: Maximum Effective Transient Thermal Impedance, Junction-to-Case

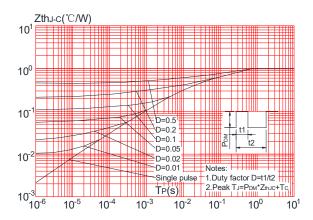


Figure 8: Normalized on Resistance vs. Junction Temperature

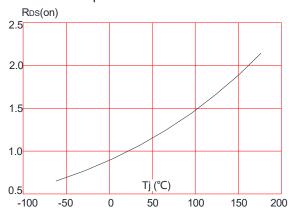
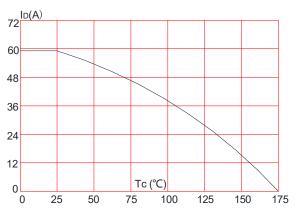


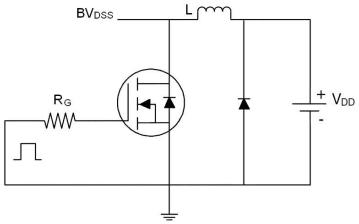
Figure 10: Maximum Continuous Drain Current vs. Case Temperature



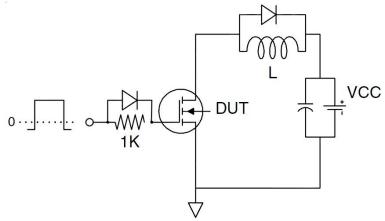


Test Circuit

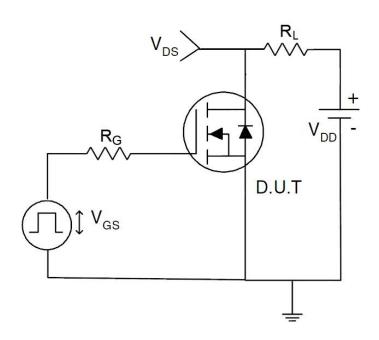
1) E_{AS} test Circuit



2) Gate charge test Circuit

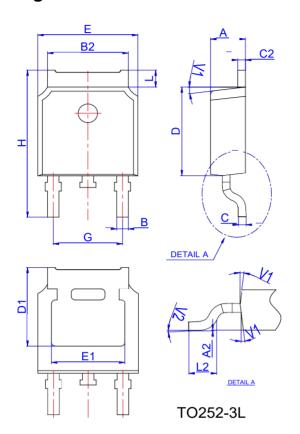


3) Switch Time Test Circuit



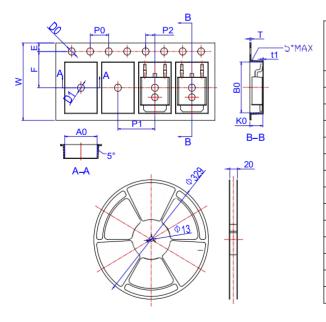


Package Mechanical Data TO252-3L



	Dimensions					
Ref.	Millimeters			Inches		
	Min.	Тур.	Max.	Min.	Тур.	Max.
Α	2.10		2.50	0.083		0.098
A2	0		0.10	0		0.004
В	0.66		0.86	0.026		0.034
B2	5.18		5.48	0.202		0.216
С	0.40		0.60	0.016		0.024
C2	0.44		0.58	0.017		0.023
D	5.90		6.30	0.232		0.248
D1		5.30REF		0.209REF		
E	6.40		6.80	0.252		0.268
E1	4.63			0.182		
G	4.47		4.67	0.176		0.184
Н	9.50		10.70	0.374		0.421
L	1.09		1.21	0.043		0.048
L2	1.35		1.65	0.053		0.065
V1		7°			7°	
V2	0°		6°	0°		6°

Reel Spectification-TO252-3L



	Dimensions					
Ref.	Millimeters			Inches		
	Min.	Тур.	Max.	Min.	Тур.	Max.
W	15.90	16.00	16.10	0.626	0.630	0.634
Е	1.65	1.75	1.85	0.065	0.069	0.073
F	7.40	7.50	7.60	0.291	0.295	0.299
D0	1.40	1.50	1.60	0.055	0.059	0.063
D1	1.40	1.50	1.60	0.055	0.059	0.063
P0	3.90	4.00	4.10	0.154	0.157	0.161
P1	7.90	8.00	8.10	0.311	0.315	0.319
P2	1.90	2.00	2.10	0.075	0.079	0.083
A0	6.85	6.90	7.00	0.270	0.271	0.276
В0	10.45	10.50	10.60	0.411	0.413	0.417
K0	2.68	2.78	2.88	0.105	0.109	0.113
Т	0.24		0.27	0.009		0.011
t1	0.10			0.004		
10P0	39.80	40.00	40.20	1.567	1.575	1.583